RJK6025DPE

Silicon N Channel MOS FET
High Speed Power Switching

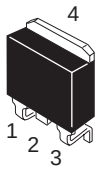
REJ03G1870-0100
Rev.1.00
Dec 08, 2009

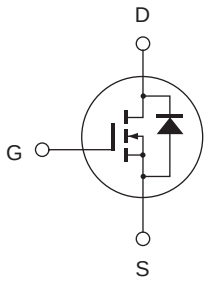
Features

- Low on-resistance
  $R_{DS(on)}$ = 13 Ω typ. (at I_D =0.4 A, V_{GS} = 10 V, Ta = 25°C)
- Low leakage current
- High speed switching

Outline

RENESAS Package code: PRSS0004AE-B
(Package name: LDPAK(S)-(1))





1. Gate
2. Drain
3. Source
4. Drain

Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	600	V
Gate to source voltage	V_{GSS}	±30	V
Drain current	I_D	0.8	A
Drain peak current	$I_{D\ (pulse)}$ Note1	1.2	A
Body-drain diode reverse drain current	I_{DR}	0.8	A
Body-drain diode reverse drain peak current	$I_{DR\ (pulse)}$ Note1	1.2	A
Channel dissipation	Pch Note2	25	W
Channel to case thermal impedance	θch-c	5	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	–55 to +150	°C

Notes: 1. PW ≤ 10 μs, duty cycle ≤ 1%
2. Value at Tc = 25°C

Electrical Characteristics

(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	600	—	—	V	I_D = 10 mA, V_{GS} = 0
Zero gate voltage drain current	I_{DSS}	—	—	1	μA	V_{DS} = 600 V, V_{GS} = 0
Gate to source leak current	I_{GSS}	—	—	±0.1	μA	V_{GS} = ±30 V, V_{DS} = 0
Gate to source cutoff voltage	$V_{GS(off)}$	3	—	5	V	V_{DS} = 10 V, I_D = 1 mA
Static drain to source on state resistance	$R_{DS(on)}$	—	13.0	17.5	Ω	I_D =0.4 A, V_{GS} = 10 V Note3
Input capacitance	Ciss	—	71.5	—	pF	V_{DS} = 25 V V_{GS} = 0 f = 1 MHz
Output capacitance	Coss	—	10.5	—	pF	
Reverse transfer capacitance	Crss	—	1.5	—	pF	
Turn-on delay time	$t_{d(on)}$	—	31	—	ns	I_D = 0.4 A V_{GS} = 10 V R_L = 750 Ω Rg = 10 Ω
Rise time	t_r	—	15	—	ns	
Turn-off delay time	$t_{d(off)}$	—	44	—	ns	
Fall time	t_f	—	44	—	ns	
Total gate charge	Qg	—	5.0	—	nC	V_{DD} = 480 V V_{GS} = 10 V I_D = 0.8 A
Gate to source charge	Qgs	—	0.7	—	nC	
Gate to drain charge	Qgd	—	3.3	—	nC	
Body-drain diode forward voltage	V_{DF}	—	0.86	1.45	V	I_F = 0.8 A, V_{GS} = 0 Note3
Body-drain diode reverse recovery time	t_{rr}	—	157	—	ns	I_F = 0.8 A, V_{GS} = 0 di_F/dt = 100 A/μs

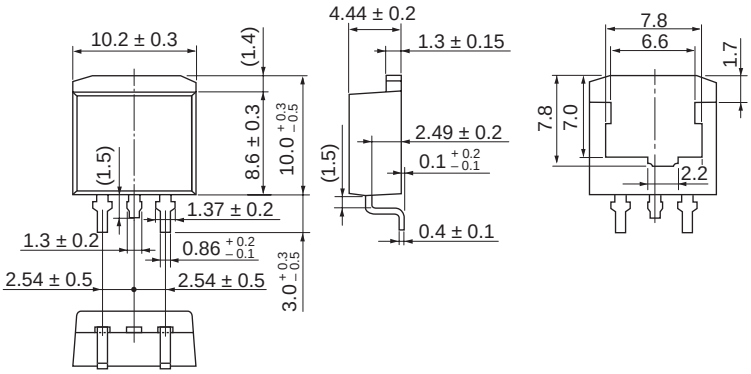
Notes: 3. Pulse test

4. This device is sensitive to electrostatic discharge.
   It is recommended to adopt appropriate cautions when handling this product.

Package Dimensions

Package Name	JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
LDPAK(S)-(1)	SC-83	PRSS0004AE-B	LDPAK(S)-(1) / LDPAK(S)-(1)V	1.30g

Unit: mm



Ordering Information

Part No.	Quantity	Shipping Container
RJK6025DPE-00-J3	1000 pcs	Taping

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